LM4041D12IDBZR Datasheet

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DiGi Electronics Part Number	LM4041D12IDBZR-DG
Manufacturer	Texas Instruments
Manufacturer Product Number	LM4041D12IDBZR
Description	IC VREF SHUNT 1% SOT23-3
Detailed Description	Shunt Voltage Reference IC Fixed 1.225V V ±1% 12 mA SOT-23-3

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RFQ Email: Info@DiGi-Electronics.com

Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
LM4041D12IDBZR	Texas Instruments
Series:	Product Status:
-	Active
Reference Type:	Output Type:
Shunt	Fixed
Voltage - Output (Min/Fixed):	Current - Output:
1.225V	12 mA
Tolerance:	Temperature Coefficient:
±1%	150ppm/°C
Noise - 0.1Hz to 10Hz:	Noise - 10Hz to 10kHz:
-	20µVrms
Voltage - Input:	Current - Supply:
-	-
Current - Cathode:	Operating Temperature:
80 µA	-40°C ~ 85°C (TA)
Mounting Type:	Package / Case:
Surface Mount	TO-236-3, SC-59, SOT-23-3
Supplier Device Package:	Base Product Number:
SOT-23-3	LM4041

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8542.39.0001	

LM4041 Precision Micropower Shunt Voltage Reference

1 Features

- 1.225V Fixed and adjustable outputs (1.225V to 10V)
- Tight output tolerances and low temperature coefficient
  - Maximum 0.1%, 100ppm/°C – A grade
  - Maximum 0.2%, 100ppm/°C – B grade
  - Maximum 0.5%, 100ppm/°C – C grade
  - Maximum 1.0%, 150ppm/°C – D grade
- Low output noise . . . 20μV_{RMS} (typical)
- Wide operating current range . . . 45µA (typical) to 12mA
- Stable with all capacitive loads; no output capacitor required
- Available in
  - Industrial temperature: –40°C to 85°C
  - Extended temperature: –40°C to 125°C

2 Applications

- Data-Acquisition Systems
- Power Supplies and Power-Supply Monitors
- Instrumentation and Test Equipment
- Process Control
- Precision Audio
- Automotive Electronics
- Energy Management/Metering
- Battery-Powered Equipment

3 Description

The LM4041 series of shunt voltage references are versatile, easy-to-use references designed for a wide array of applications. These parts do not require external capacitors for operation and are stable with all capacitive loads. Additionally, the reference offers low dynamic impedance, low noise, and a low temperature coefficient to maintain a stable output voltage over a wide range of operating currents and temperatures. The LM4041 uses fuse and Zener-zap reverse breakdown voltage trim during wafer sort to offer four output voltage tolerances, ranging from 0.1% (maximum) for the A grade to 1% (maximum) for the D grade. Thus, a great deal of flexibility is offered to designers in choosing the best cost-to-performance ratio for applications. The LM4041 is available in a fixed (1.225V nominal) or an adjustable version (which requires an external resistor divider to set the output to a value between 1.225V and 10V).

Packaged in space-saving SC-70 and SOT-23-3 and requiring a minimum current of 45µA (typical), the LM4041 also designed for portable applications. The TO-92 package also is available for through-hole packaging needs. The LM4041xI is characterized for operation over an ambient temperature range of –40°C to 85°C. The LM4041xQ is characterized for operation over an ambient temperature range of –40°C to 125°C.

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4 Pin Configuration and Functions

Pin Functions

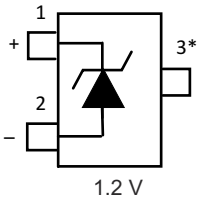


Figure 4-1. DBZ Package
3-Pin SOT-23
Top View

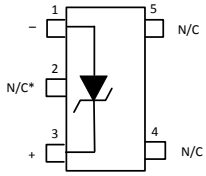


Figure 4-2. DCK Package
5-Pin SC70
Top View

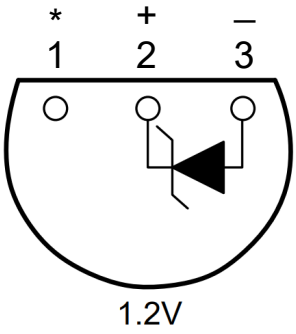


Figure 4-3. LP Package
3-Pin TO-92
Bottom View

Pin Functions

PIN				I/O	DESCRIPTION
NAME	SOT-23	SC70	TO-92		
Anode	2	1	3	O	Anode pin, normally grounded
Cathode	1	3	2	I/O	Shunt current and output voltage
FB	—	—	—	I	Feedback pin for adjustable output voltage
NC*	3	2	1	—	**Must float or connect to anode (1)
NC	—	4, 5	—	—	No connect

(1) **In applications with high electromagnetic interference (for example, when placed near transformers or other electromagnetic sources) or significant high-frequency switching noise, TI recommends to connect this pin to the anode.**

Pin Functions: ADJ Pinouts

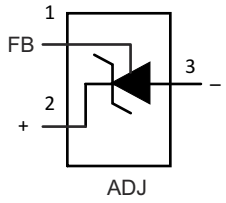


Figure 4-4. DBZ Package
3-Pin SOT-23
Top View

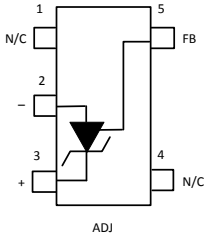


Figure 4-5. DCK Package
5-Pin SC70
Top View

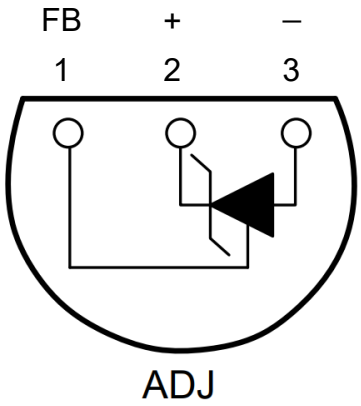


Figure 4-6. LP Package
3-Pin TO-92
Bottom View

PIN				I/O	DESCRIPTION
NAME	SOT-23	SC70	TO-92		
Anode	3	2	3	O	Anode pin, normally grounded
Cathode	2	3	2	I/O	Shunt current and output voltage
FB	1	5	1	I	Feedback pin for adjustable output voltage
NC**	—	—	—	—	**Must float or connect to anode
NC	—	1, 4	—	—	No connect

5 Specifications

5.1 Absolute Maximum Ratings

over free-air temperature range (unless otherwise noted)

			MIN	MAX [1]	UNIT
V_Z	Continuous cathode voltage			15	V
I_Z	Continuous cathode current		–10	25	mA
θ_{JA}	Package thermal impedance[2] [3]	DBZ package		206	°C/W
		DCK package		252	
		LP package		156	
T_J	Operating virtual junction temperature			150	°C
T_{stg}	Storage temperature range		–65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" can cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods can affect device reliability.
(2) Maximum power dissipation is a function of $T_J(max)$, θ_{JA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) – T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
(3) The package thermal impedance is calculated in accordance with JESD 51-7.

5.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic Discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 [1] [2]	±2000	V
		Charged-device model (CDM), per JEDEC specification JESD22-C101 [3]	±500	

(1) JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process.
(2) The human-body model is a 100pF capacitor discharged through a 1.5kΩ resistor into each pin. The machine model is a 200pF capacitor discharged directly into each pin. All pins are rated at 2kV for human-body model, but the feedback pin which is rated at 1kV.
(3) JEDEC document JEP157 states that 250V CDM allows safe manufacturing with a standard ESD control process. Manufacturing with less than 250V CDM is possible with the necessary precautions.

5.3 Recommended Operating Conditions

			MIN	MAX	UNIT
I_Z	Cathode current		(1)	12	mA
V_Z	Reverse breakdown voltage (adjustable version)			10	V
T_A	Free-air temperature	LM4041 (I temperature)	–40	85	°C
		LM4041 (Q temperature)	–40	125	

(1) See parametric tables

5.4 LM4041x12I Electrical Characteristics

full-range T_A = –40°C to 85°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T_A	LM4041A12I			LM4041B12I			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
V_Z	Reverse breakdown voltage	I_Z = 100µA	25°C		1.225			1.225		V
	Reverse breakdown voltage tolerance	I_Z = 100µA	25°C	–1.2		1.2	–2.4		2.4	mV
			Full range	–9.2		9.2	–10.4		10.4	
$I_{Z,min}$	Minimum cathode current		25°C		45	75		45	75	µA
			Full range			80			80	
α_{VZ}	Average temperature coefficient of reverse breakdown voltage	I_Z = 10mA	25°C		±20			±20		ppm/°C
		I_Z = 1mA	25°C		±15			±15		
			Full range			±100			±100	
		I_Z = 100µA	25°C		±15			±15		
$\Delta V_Z/\Delta I_Z$	Reverse breakdown voltage change with cathode current change	$I_{Z,min} < I_Z < 1$mA	25°C		0.7	1.5		0.7	1.5	mV
			Full range			2			2	
		1mA < I_Z < 12mA	25°C		4	6		4	6	
			Full range			8			8	
Z_Z	Reverse dynamic impedance	I_Z = 1mA, f = 120Hz, I_{AC} = 0.1 I_Z	25°C		0.5	1.5		0.5	1.5	Ω
e_N	Wideband noise	I_Z = 100µA, 10Hz ≤ f ≤ 10kHz	25°C		20			20		μV_{RMS}
	Long-term stability of reverse breakdown voltage	t = 1000 h, T_A = 25°C ± 0.1°C, I_Z = 100µA	25°C		120			120		ppm

5.5 LM4041x12I Electrical Characteristics

full-range T_A = –40°C to 85°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T_A	LM4041C12I			LM4041D12I			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
V_Z	Reverse breakdown voltage	I_Z = 100µA	25°C		1.225			1.225		V
	Reverse breakdown voltage tolerance	I_Z = 100µA	25°C	–6		6	–12		12	mV
			Full range	–14		14	–24		24	
$I_{Z,min}$	Minimum cathode current		25°C		45	75		45	75	µA
			Full range			80			80	
α_{VZ}	Average temperature coefficient of reverse breakdown voltage	I_Z = 10mA	25°C		±20			±20		ppm/°C
		I_Z = 1mA	25°C		±15			±15		
			Full range			±100			±150	
		I_Z = 100µA	25°C		±15			±15		
$\Delta V_Z/\Delta I_Z$	Reverse breakdown voltage change with cathode current change	$I_{Z,min} < I_Z < 1$mA	25°C		0.7	1.5		0.7	2	mV
			Full range			2			2.5	
		1mA < I_Z < 12mA	25°C		2.5	6		2.5	8	
			Full range			8			10	
Z_Z	Reverse dynamic impedance	I_Z = 1mA, f = 120Hz, I_{AC} = 0.1 I_Z	25°C		0.5	1.5		0.5	2	Ω
e_N	Wideband noise	I_Z = 100µA, 10Hz ≤ f ≤ 10kHz	25°C		20			20		μV_{RMS}
	Long-term stability of reverse breakdown voltage	t = 1000 h, T_A = 25°C ± 0.1°C, I_Z = 100µA	25°C		120			120		ppm

5.6 LM4041x12Q Electrical Characteristics

full-range T_A = –40°C to 125°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T_A	LM4041C12Q			LM4041D12Q			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
V_Z	Reverse breakdown voltage	I_Z = 100µA	25°C		1.225			1.225		V
	Reverse breakdown voltage tolerance	I_Z = 100µA	25°C	–6		6	–12		12	mV
			Full range	–18.4		18.4	–31		31	
$I_{Z,min}$	Minimum cathode current		25°C		45	75		45	75	µA
			Full range			80			80	
α_{VZ}	Average temperature coefficient of reverse breakdown voltage	I_Z = 10mA	25°C		±20			±20		ppm/°C
		I_Z = 1mA	25°C		±15			±15		
			Full range			±100			±150	
		I_Z = 100µA	25°C		±15			±15		
$\Delta V_Z/\Delta I_Z$	Reverse breakdown voltage change with cathode current change	$I_{Z,min} < I_Z < 1$mA	25°C		0.7	1.5		0.7	2	mV
			Full range			2			2.5	
		1mA < I_Z < 12mA	25°C		2.5	6		2.5	8	
			Full range			8			10	
Z_Z	Reverse dynamic impedance	I_Z = 1mA, f = 120Hz, I_{AC} = 0.1 I_Z	25°C		0.5			0.5		Ω
			Full range			1.5			2	
e_N	Wideband noise	I_Z = 100µA, 10Hz ≤ f ≤ 10kHz	25°C		20			20		μV_{RMS}
	Long-term stability of reverse breakdown voltage	t = 1000 h, T_A = 25°C ± 0.1°C, I_Z = 100µA	25°C		120			120		ppm

5.7 LM4041xI (Adjustable Version) Electrical Characteristics

full-range T_A = –40°C to 85°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T_A	LM4041BI			LM4041CI			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
V_{REF}	Reference voltage	I_Z = 100µA, V_Z = 5V	25°C		1.233			1.233		V
	Reference voltage tolerance(1)	I_Z = 100µA, V_Z = 5V	25°C	–2.5		2.5	–6.2		6.2	mV
			Full range	–10.5		10.5	–14		14	
$I_{Z,min}$	Minimum cathode current		25°C		45	75		45	75	µA
			Full range			80			80	
$\Delta V_{REF}/\Delta I_Z$	Reference voltage change with cathode current change	$I_{Z,min} < I_Z < 1$mA	25°C		0.7	1.5		0.7	1.5	mV
			Full range			2			2	
		1mA < I_Z < 12mA	25°C		2	4		2	4	
			Full range			6			6	
$\Delta V_{REF}/\Delta V_{KA}$	Reference voltage change with output voltage change	I_Z = 1mA	25°C		–1.55	–2		–1.55	–2	mV/V
			Full range			–2.5			–2.5	
I_{FB}	Feedback current		25°C		60	100		60	100	nA
			Full range			120			120	
αV_{REF}	Average temperature coefficient of reference voltage(1)	I_Z = 10mA, V_Z = 5V	25°C		±20			±20		ppm/°C
		I_Z = 1mA, V_Z = 5V	25°C		±15			±15		
			Full range			±100			±100	
		I_Z = 100µA, V_Z = 5V	25°C		±15			±15		
Z_Z	Reverse dynamic impedance	I_Z = 1mA, f = 120Hz, I_{AC} = 0.1 I_Z, V_Z = V_{REF}	25°C		0.3			0.3		Ω
		I_Z = 1mA, f = 120Hz, I_{AC} = 0.1 I_Z, V_Z = 10V	25°C		2			2		
e_N	Wideband noise	I_Z = 100µA, V_Z = V_{REF}, 10Hz ≤ f ≤ 10kHz	25°C		20			20		μV_{RMS}
	Long-term stability of reverse breakdown voltage	t = 1000 h, T_A = 25°C ± 0.1°C, I_Z = 100µA	25°C		120			120		ppm

(1) Reference voltage tolerance and average temperature coefficient change with output voltage (V_Z). See *Typical Characteristics*.

5.8 LM4041xI (Adjustable Version) Electrical Characteristics

full-range T_A = –40°C to 85°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T_A	LM4041DI			UNIT
				MIN	TYP	MAX	
V_{REF}	Reference voltage	I_Z = 100µA, V_Z = 5V	25°C		1.233		V
	Reference voltage tolerance(1)	I_Z = 100µA, V_Z = 5V	25°C	–12		12	mV
			Full range	–24		24	
$I_{Z,min}$	Minimum cathode current		25°C		45	75	µA
			Full range			80	
$\Delta V_{REF}/\Delta I_Z$	Reference voltage change with cathode current change	$I_{Z,min}$ < I_Z < 1mA	25°C		0.7	2	mV
			Full range			2.5	
		1mA < I_Z < 12mA	25°C		2	6	
			Full range			8	
$\Delta V_{REF}/\Delta V_{KA}$	Reference voltage change with output voltage change	I_Z = 1mA	25°C		–1.55	–2	mV/V
			Full range			–3	
I_{FB}	Feedback current		25°C		60	150	nA
			Full range			200	
αV_{REF}	Average temperature coefficient of reference voltage(1)	I_Z = 10mA, V_Z = 5V	25°C		±20		ppm/°C
		I_Z = 1mA, V_Z = 5V	25°C		±15		
			Full range			±150	
		I_Z = 100µA, V_Z = 5V	25°C		±15		
Z_Z	Reverse dynamic impedance	I_Z = 1mA, f = 120Hz, I_{AC} = 0.1 I_Z, V_Z = V_{REF}	25°C		0.3		Ω
		I_Z = 1mA, f = 120Hz, I_{AC} = 0.1 I_Z, V_Z = 10V	25°C		2		
e_N	Wideband noise	I_Z = 100µA, V_Z = V_{REF}, 10Hz ≤ f ≤ 10kHz	25°C		20		μV_{RMS}
	Long-term stability of reverse breakdown voltage	t = 1000 h, T_A = 25°C ± 0.1°C, I_Z = 100µA	25°C		120		ppm

(1) Reference voltage tolerance and average temperature coefficient change with output voltage (V_Z). See *Typical Characteristics*.

5.9 LM4041xQ (Adjustable Version) Electrical Characteristics

full-range T_A = –40°C to 125°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T_A	LM4041CQ			LM4041DQ			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
V_{REF}	Reference voltage	I_Z = 100µA, V_Z = 5V	25°C		1.233			1.233		V
	Reference voltage tolerance(1)	I_Z = 100µA, V_Z = 5V	25°C	–6.2		6.2	–12		12	mV
			Full range	–18		18	–30		30	
$I_{Z,min}$	Minimum cathode current		25°C		45	75		45	75	µA
			Full range			80			80	
$\Delta V_{REF}/\Delta I_Z$	Reference voltage change with cathode current change	$I_{Z,min}$ < I_Z < 1mA	25°C		0.7	1.5		0.7	2	mV
			Full range			2			2.5	
		1mA < I_Z < 12mA	25°C		2	4		2	6	
			Full range			8			10	
$\Delta V_{REF}/\Delta V_{KA}$	Reference voltage change with output voltage change	I_Z = 1mA	25°C		–1.55	–2		–1.55	–2.5	mV/V
			Full range			–3			–4	
I_{FB}	Feedback current		25°C		60	100		60	150	nA
			Full range			120			200	
αV_{REF}	Average temperature coefficient of reference voltage(1)	I_Z = 10mA, V_Z = 5V	25°C		±20			±20		ppm/°C
		I_Z = 1mA, V_Z = 5V	25°C		±15			±15		
			Full range			±100			±150	
		I_Z = 100µA, V_Z = 5V	25°C		±15			±15		
Z_Z	Reverse dynamic impedance	I_Z = 1mA, f = 120Hz, I_{AC} = 0.1 I_Z, V_Z = V_{REF}	25°C		0.3			0.3		Ω
		I_Z = 1mA, f = 120Hz, I_{AC} = 0.1 I_Z, V_Z = 10V	25°C		2			2		
e_N	Wideband noise	I_Z = 100µA, V_Z = V_{REF}, 10Hz ≤ f ≤ 10kHz	25°C		20			20		μV_{RMS}
	Long-term stability of reverse breakdown voltage	t = 1000 h, T_A = 25°C ± 0.1°C, I_Z = 100µA	25°C		120			120		ppm

(1) Reference voltage tolerance and average temperature coefficient change with output voltage (V_Z). See *Typical Characteristics*.

5.10 Typical Characteristics

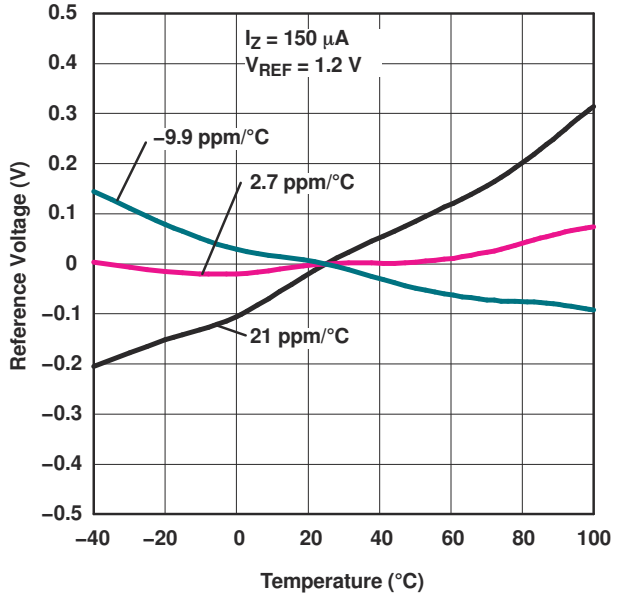


Figure 5-1. Temperature Drift for Different Average Temperature Coefficients

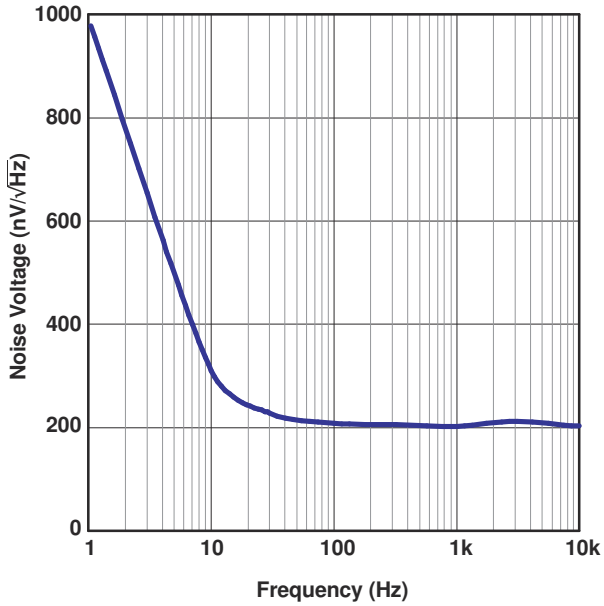


Figure 5-2. Noise Voltage vs Frequency

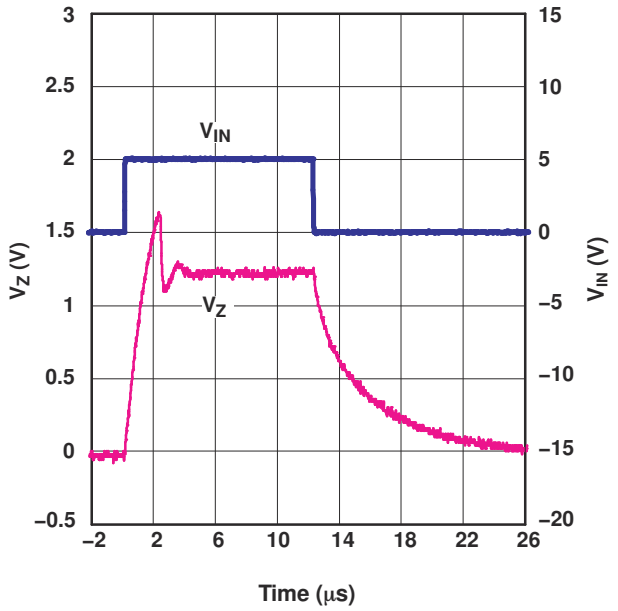


Figure 5-3. Start-Up Characteristics

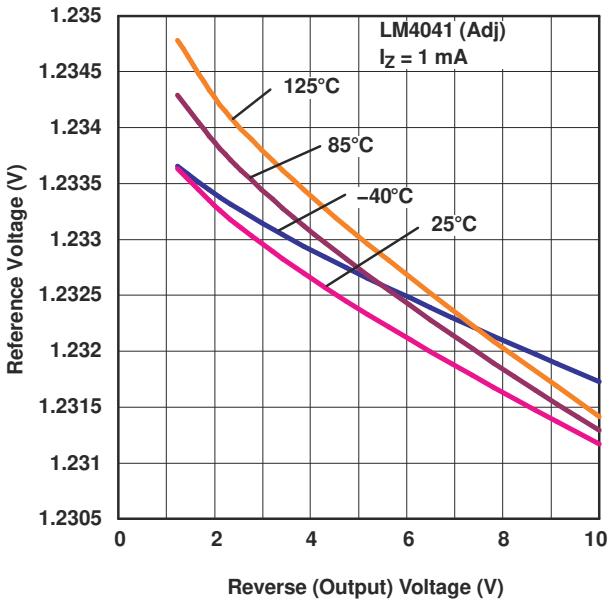


Figure 5-4. Reference Voltage vs Reverse (Output) Voltage (for Different Temperatures)

5.10 Typical Characteristics (continued)

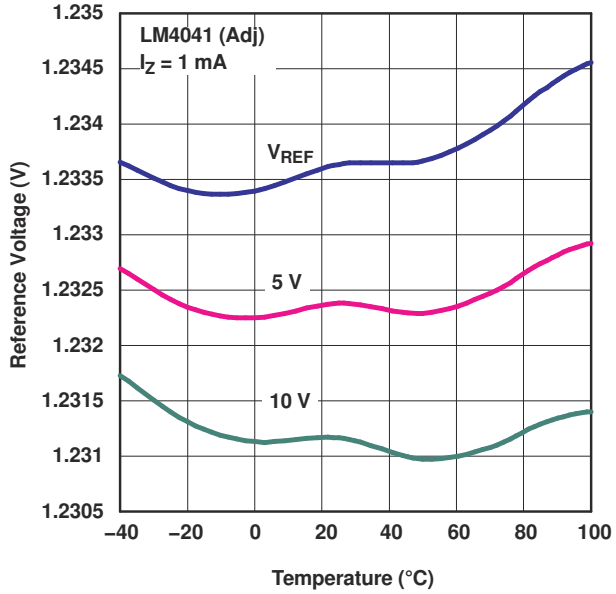


Figure 5-5. Reference Voltage vs Temperature (for Different Reverse Voltages)

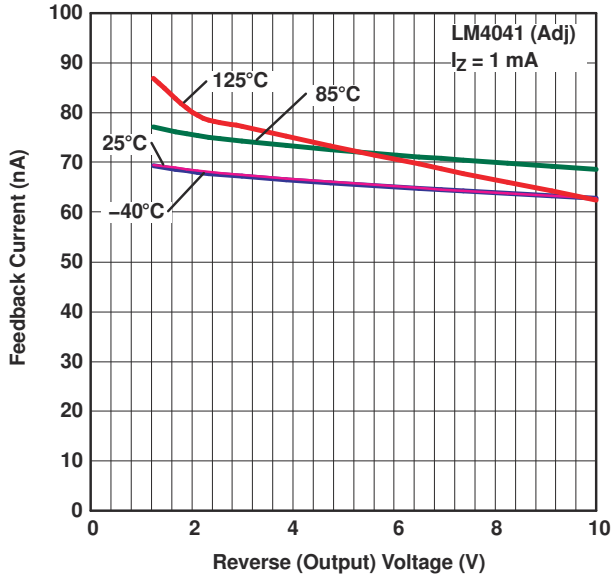


Figure 5-6. Feedback Current vs Reverse (Output) Voltage (for Different Temperatures)

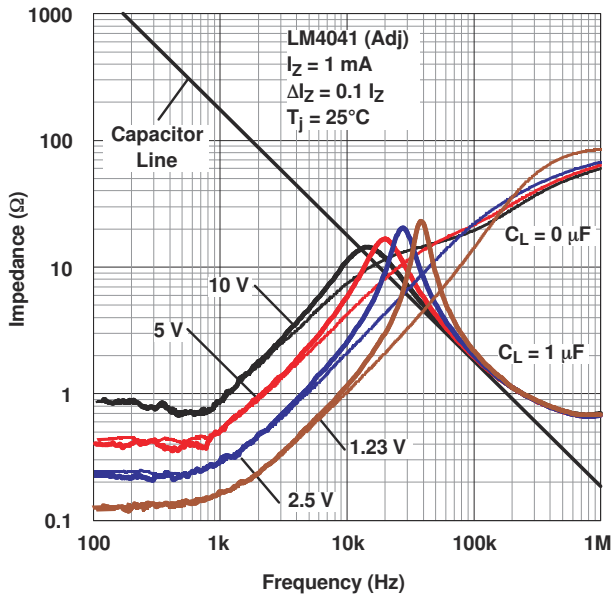


Figure 5-7. Output Impedance vs Frequency

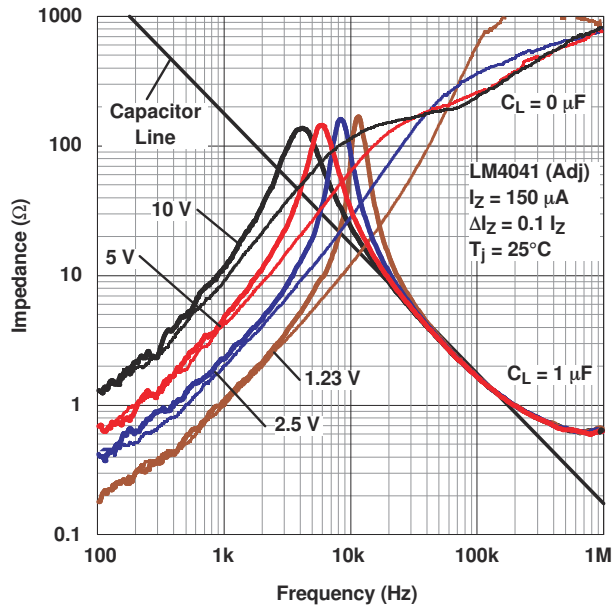


Figure 5-8. Output Impedance vs Frequency

5.10 Typical Characteristics (continued)

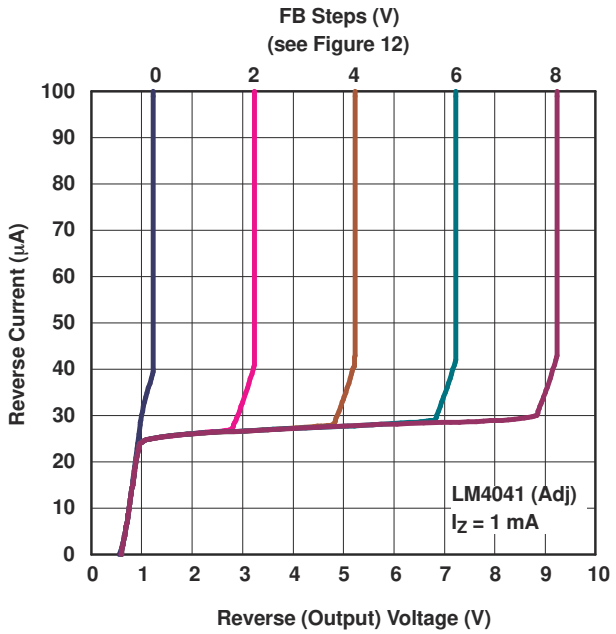


Figure 5-9. Reverse Characteristics

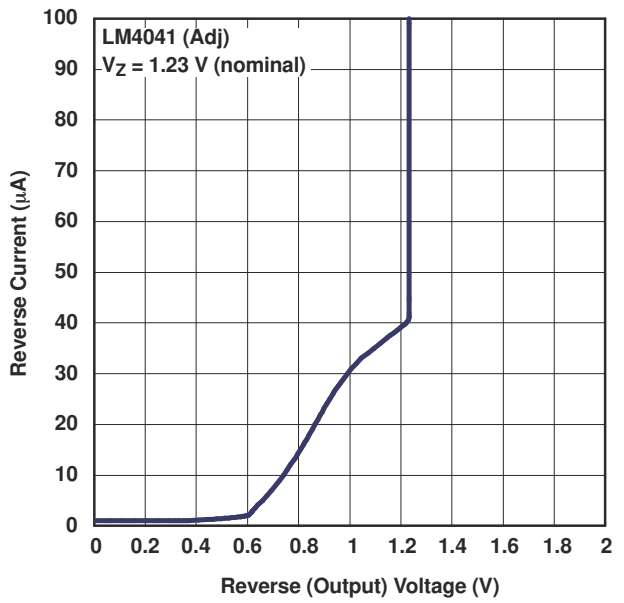


Figure 5-10. Reverse Characteristics and Minumum Operating Current

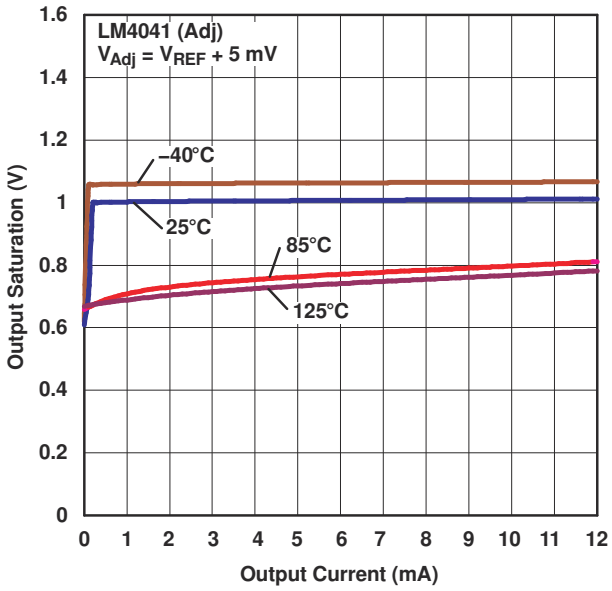


Figure 5-11. Output Saturation vs Output Current

6 Functional Block Diagram

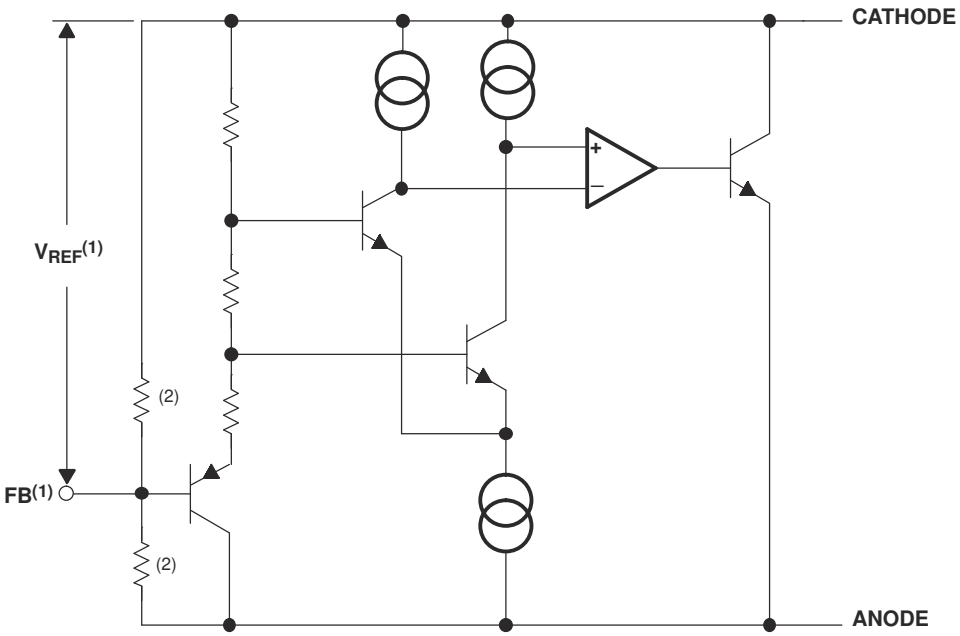


Figure 6-1. Functional Block Diagram

7 Application Information

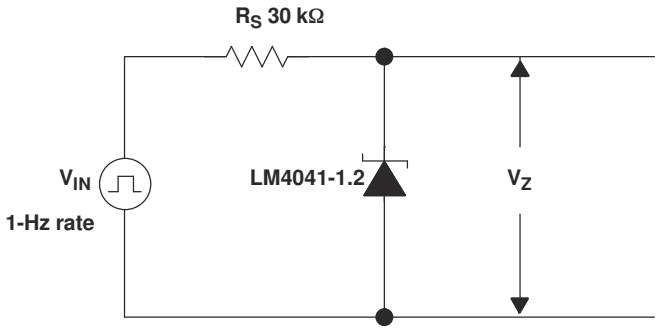


Figure 7-1. Startup Characteristics Test Circuit

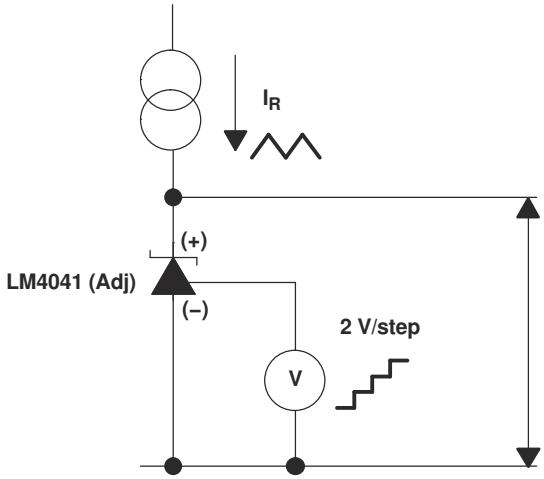


Figure 7-2. Reverse Characteristics Test Circuit

7.1 Output Capacitor

The LM4041 does not require an output capacitor across CATHODE and ANODE for stability. However, if an output bypass capacitor is desired, the LM4041 is designed to be stable with all capacitive loads.

7.2 SOT-23 and SC-70 Pin Connections

There is a parasitic Schottky diode connected between pins 2 and 3 of the SOT-23 packaged device. Thus, pin 3 of the SOT-23 package must be left floating or connected to pin 2. Similarly, pin 2 of the SC-70 package also must be left floating or connected to pin 1.

7.3 Adjustable Version

The adjustable version allows V_Z to be set by a user-defined resistor divider. The output voltage, V_Z, is set according to the equation shown in Figure 7-3.

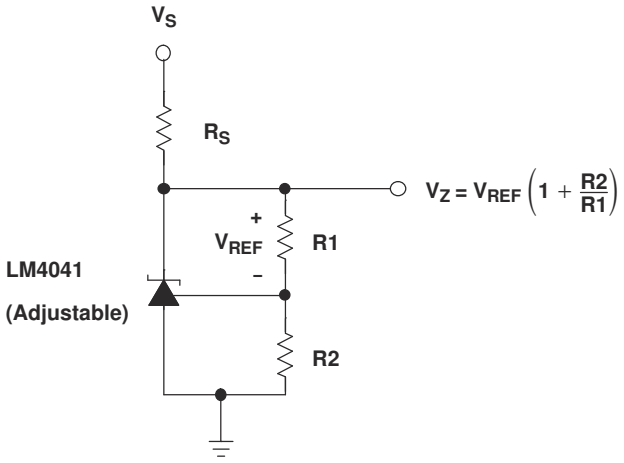


Figure 7-3. Adjustable Shunt Regulator

When the output voltage, V_Z, is set below 2.5V on adjustable versions of LM4041, the device can experience increased reference voltage change with output voltage change ($\Delta V_{REF}/\Delta V_{KA}$) when compared to output voltages set equal to or above 2.5V.

7.4 Cathode and Load Currents

In a typical shunt regulator configuration (see Figure 7-4), an external resistor, R_S, is connected between the supply and the cathode of the LM4041. R_S must be set properly, this sets the total current available to supply the load (I_L) and bias the LM4041 (I_Z). In all cases, I_Z must stay within a specified range for proper operation of the reference. Taking into consideration one extreme in the variation of the load and supply voltage (maximum I_L and minimum V_S), R_S must be small enough to supply the minimum I_Z required for operation of the regulator, as given by data sheet parameters. At the other extreme, maximum V_S and minimum I_L, R_S must be large enough to limit I_Z to less than the maximum recommended rating of 12mA.

R_S is calculated as shown in Equation 1.

$$R_S = \frac{(V_S - V_Z)}{(I_L + I_Z)} \tag{1}$$

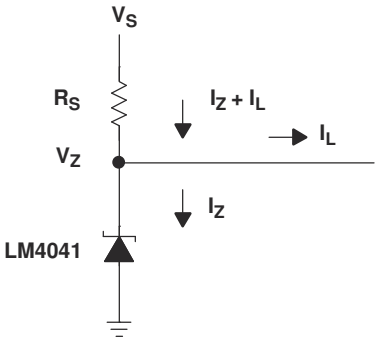


Figure 7-4. Shunt Regulator

8 Device and Documentation Support

8.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

8.2 Trademarks

TI E2E™ is a trademark of Texas Instruments.
All trademarks are the property of their respective owners.

8.3 Electrostatic Discharge Caution

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

8.4 Support Resources

TI E2E™ support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

8.5 Glossary

TI Glossary	This glossary lists and explains terms, acronyms, and definitions.

9 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision G (July 2024) to Revision H (March 2025)	Page
• Updated LP pin numbering	3
• Added electromagnetic interference note and updated LP pinout numbering	3
• Added ESD ratings	5
• Added reference voltage change with output voltage change details	17

Changes from Revision F (September 2020) to Revision G (July 2024)	Page
• Updated *Applications* links	1
• Updated pinout diagrams	3

Changes from Revision E (February 2006) to Revision F (September 2020) **Page**

- Updated the numbering format for tables, figures and cross-references throughout the document..... 1
- Deleted *Ordering Information* table. See Mechanical, Packaging, and Orderable Information at the end of the data sheet.....15

10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

TEXAS INSTRUMENTS

www.ti.com

PACKAGE OPTION ADDENDUM

8-Jan-2026

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM4041A12IDBZR	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	(4MK3, 4MKU)
LM4041A12IDBZR.A	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MK3, 4MKU)
LM4041A12IDBZT	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MK3, 4MKU)
LM4041A12IDBZT.A	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MK3, 4MKU)
LM4041A12IDBZT1G4	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	4MK3
LM4041A12IDBZT1G4.A	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	4MK3
LM4041A12IDCKR	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	MKU
LM4041A12IDCKR.A	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	MKU
LM4041B12IDBZR	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4ML3, 4MLU)
LM4041B12IDBZR.A	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4ML3, 4MLU)
LM4041B12IDBZT	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4ML3, 4MLU)
LM4041B12IDBZT.A	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4ML3, 4MLU)
LM4041B12IDCKR	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	MLU
LM4041B12IDCKR.A	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	MLU
LM4041BIDBZR	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MG3, 4MGU)
LM4041BIDBZR.A	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MG3, 4MGU)
LM4041BIDBZR1G4	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MG3, 4MGU)
LM4041BIDBZR1G4.A	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MG3, 4MGU)
LM4041BIDBZT	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MG3, 4MGU)
LM4041BIDBZT.A	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MG3, 4MGU)
LM4041BIDCKR	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MGU
LM4041BIDCKR.A	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MGU
LM4041BIDCKT	Active	Production	SC70 (DCK) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MGU
LM4041BIDCKT.A	Active	Production	SC70 (DCK) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MGU
LM4041C12IDBZR	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MM3, 4MMU)
LM4041C12IDBZR.A	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MM3, 4MMU)
LM4041C12IDBZR1G4	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	4MM3
LM4041C12IDBZR1G4.A	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	4MM3
LM4041C12IDBZT	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MM3, 4MMU)

TEXAS INSTRUMENTS

PACKAGE OPTION ADDENDUM

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM4041C12IDBZT.A	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MM3, 4MMU)
LM4041C12IDCKR	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	MMU
LM4041C12IDCKR.A	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	MMU
LM4041C12IDCKRE4	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	-	Call TI	Call TI	-40 to 85	
LM4041C12IDCKRG4	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	-	Call TI	Call TI	-40 to 85	
LM4041C12ILP	Active	Production	TO-92 (LP) | 3	1000 | BULK	Yes	SN	N/A for Pkg Type	-40 to 85	NPC12I
LM4041C12ILP.A	Active	Production	TO-92 (LP) | 3	1000 | BULK	Yes	SN	N/A for Pkg Type	-40 to 85	NPC12I
LM4041C12ILPR	Active	Production	TO-92 (LP) | 3	2000 | LARGE T&R	Yes	SN	N/A for Pkg Type	-40 to 85	NPC12I
LM4041C12ILPR.A	Active	Production	TO-92 (LP) | 3	2000 | LARGE T&R	Yes	SN	N/A for Pkg Type	-40 to 85	NPC12I
LM4041C12QDBZR	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MS3, 4MSU)
LM4041C12QDBZR.A	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MS3, 4MSU)
LM4041C12QDBZT	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MS3, 4MSU)
LM4041C12QDBZT.A	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MS3, 4MSU)
LM4041CIDBZR	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MH3, 4MHU)
LM4041CIDBZR.A	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MH3, 4MHU)
LM4041CIDBZT	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MH3, 4MHU)
LM4041CIDBZT.A	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MH3, 4MHU)
LM4041CIDCKR	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MHU
LM4041CIDCKR.A	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MHU
LM4041CIDCKT	Active	Production	SC70 (DCK) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MHU
LM4041CIDCKT.A	Active	Production	SC70 (DCK) | 5	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MHU
LM4041CILP	Obsolete	Production	TO-92 (LP) | 3	-	-	Call TI	Call TI	-40 to 85	NPCI
LM4041CILPE3	NRND	Production	TO-92 (LP) | 3	1000 | BULK	-	Call TI	Call TI	-40 to 85	
LM4041CILPR	Active	Production	TO-92 (LP) | 3	2000 | LARGE T&R	Yes	SN	N/A for Pkg Type	-40 to 85	NPCI
LM4041CILPR.A	Active	Production	TO-92 (LP) | 3	2000 | LARGE T&R	Yes	SN	N/A for Pkg Type	-40 to 85	NPCI
LM4041CQDBZR	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MP3, 4MPU)
LM4041CQDBZR.A	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MP3, 4MPU)
LM4041CQDBZT	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MP3, 4MPU)
LM4041CQDBZT.A	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MP3, 4MPU)
LM4041D12IDBZR	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MN3, 4MNU)
LM4041D12IDBZR.A	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MN3, 4MNU)

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM4041D12IDBZR1G4	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	4MN3
LM4041D12IDBZR1G4.A	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	4MN3
LM4041D12IDBZT	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MN3, 4MNU)
LM4041D12IDBZT.A	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MN3, 4MNU)
LM4041D12IDCKR	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	NIPDAU | SN	Level-1-260C-UNLIM	-40 to 85	MNU
LM4041D12IDCKR.A	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	MNU
LM4041D12ILP	Active	Production	TO-92 (LP) | 3	1000 | BULK	Yes	SN	N/A for Pkg Type	-40 to 85	NPD12I
LM4041D12ILP.A	Active	Production	TO-92 (LP) | 3	1000 | BULK	Yes	SN	N/A for Pkg Type	-40 to 85	NPD12I
LM4041D12ILPE3	Active	Production	TO-92 (LP) | 3	1000 | BULK	-	Call TI	Call TI	-40 to 85	
LM4041D12ILPR	Active	Production	TO-92 (LP) | 3	2000 | LARGE T&R	Yes	SN	N/A for Pkg Type	-40 to 85	NPD12I
LM4041D12ILPR.A	Active	Production	TO-92 (LP) | 3	2000 | LARGE T&R	Yes	SN	N/A for Pkg Type	-40 to 85	NPD12I
LM4041D12QDBZR	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MT3, 4MTU)
LM4041D12QDBZR.A	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MT3, 4MTU)
LM4041DIDBZR	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MJ3, 4MJU)
LM4041DIDBZR.A	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MJ3, 4MJU)
LM4041DIDBZT	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MJ3, 4MJU)
LM4041DIDBZT.A	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(4MJ3, 4MJU)
LM4041DIDCKR	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MJU
LM4041DIDCKR.A	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MJU
LM4041DIDCKRG4	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MJU
LM4041DIDCKRG4.A	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	MJU
LM4041DILP	Obsolete	Production	TO-92 (LP) | 3	-	-	Call TI	Call TI	-40 to 85	NPDI
LM4041DILPR	Active	Production	TO-92 (LP) | 3	2000 | LARGE T&R	Yes	SN	N/A for Pkg Type	-40 to 85	NPDI
LM4041DILPR.A	Active	Production	TO-92 (LP) | 3	2000 | LARGE T&R	Yes	SN	N/A for Pkg Type	-40 to 85	NPDI
LM4041DQDBZR	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MR3, 4MRU)
LM4041DQDBZR.A	Active	Production	SOT-23 (DBZ) | 3	3000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MR3, 4MRU)
LM4041DQDBZT	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MR3, 4MRU)
LM4041DQDBZT.A	Active	Production	SOT-23 (DBZ) | 3	250 | SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	(4MR3, 4MRU)

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

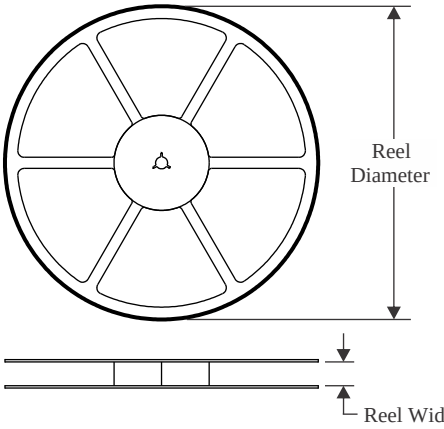
Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

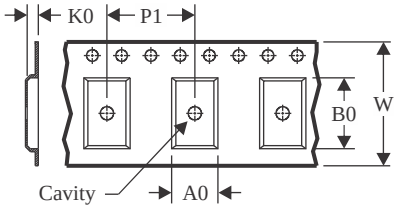
PACKAGE MATERIALS INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS

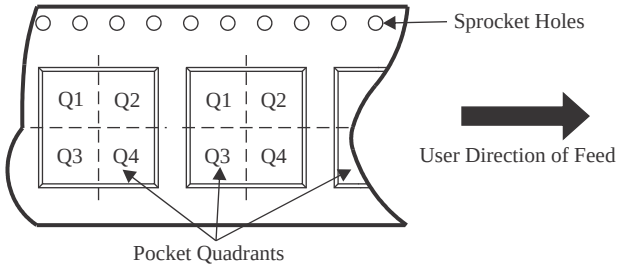


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM4041A12IDBZR	SOT-23	DBZ	3	3000	180.0	8.4	2.9	3.35	1.35	4.0	8.0	Q3
LM4041A12IDBZT	SOT-23	DBZ	3	250	180.0	8.4	2.9	3.35	1.35	4.0	8.0	Q3
LM4041A12IDBZT1G4	SOT-23	DBZ	3	250	180.0	8.4	2.9	3.35	1.35	4.0	8.0	Q3
LM4041A12IDCKR	SC70	DCK	5	3000	180.0	8.4	2.3	2.5	1.2	4.0	8.0	Q3
LM4041A12IDCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LM4041B12IDBZR	SOT-23	DBZ	3	3000	180.0	8.4	2.9	3.35	1.35	4.0	8.0	Q3
LM4041B12IDBZT	SOT-23	DBZ	3	250	180.0	8.4	2.9	3.35	1.35	4.0	8.0	Q3
LM4041B12IDCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LM4041B12IDCKR	SC70	DCK	5	3000	180.0	8.4	2.3	2.5	1.2	4.0	8.0	Q3
LM4041BIDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041BIDBZR	SOT-23	DBZ	3	3000	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041BIDBZR1G4	SOT-23	DBZ	3	3000	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041BIDBZR1G4	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041BIDBZT	SOT-23	DBZ	3	250	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041BIDBZT	SOT-23	DBZ	3	250	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041BIDCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3

PACKAGE MATERIALS INFORMATION

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM4041BIDCKT	SC70	DCK	5	250	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LM4041C12IDBZR	SOT-23	DBZ	3	3000	180.0	8.4	2.9	3.35	1.35	4.0	8.0	Q3
LM4041C12IDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041C12IDBZR1G4	SOT-23	DBZ	3	3000	180.0	8.4	2.9	3.35	1.35	4.0	8.0	Q3
LM4041C12IDBZT	SOT-23	DBZ	3	250	180.0	8.4	2.9	3.35	1.35	4.0	8.0	Q3
LM4041C12IDCKR	SC70	DCK	5	3000	180.0	8.4	2.3	2.5	1.2	4.0	8.0	Q3
LM4041C12IDCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LM4041C12QDBZR	SOT-23	DBZ	3	3000	180.0	8.4	2.9	3.35	1.35	4.0	8.0	Q3
LM4041C12QDBZT	SOT-23	DBZ	3	250	180.0	8.4	2.9	3.35	1.35	4.0	8.0	Q3
LM4041CIDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041CIDBZR	SOT-23	DBZ	3	3000	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041CIDBZT	SOT-23	DBZ	3	250	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041CIDBZT	SOT-23	DBZ	3	250	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041CIDCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LM4041CIDCKT	SC70	DCK	5	250	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LM4041CQDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041CQDBZR	SOT-23	DBZ	3	3000	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041CQDBZT	SOT-23	DBZ	3	250	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041CQDBZT	SOT-23	DBZ	3	250	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041D12IDBZR	SOT-23	DBZ	3	3000	180.0	8.4	2.9	3.35	1.35	4.0	8.0	Q3
LM4041D12IDBZR1G4	SOT-23	DBZ	3	3000	180.0	8.4	2.9	3.35	1.35	4.0	8.0	Q3
LM4041D12IDBZT	SOT-23	DBZ	3	250	180.0	8.4	2.9	3.35	1.35	4.0	8.0	Q3
LM4041D12IDCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LM4041D12IDCKR	SC70	DCK	5	3000	180.0	8.4	2.3	2.5	1.2	4.0	8.0	Q3
LM4041D12QDBZR	SOT-23	DBZ	3	3000	180.0	8.4	2.9	3.35	1.35	4.0	8.0	Q3
LM4041DIDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041DIDBZR	SOT-23	DBZ	3	3000	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041DIDBZT	SOT-23	DBZ	3	250	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041DIDCKR	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LM4041DIDCKRG4	SC70	DCK	5	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LM4041DQDBZR	SOT-23	DBZ	3	3000	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3
LM4041DQDBZR	SOT-23	DBZ	3	3000	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041DQDBZT	SOT-23	DBZ	3	250	179.0	8.4	3.15	2.95	1.22	4.0	8.0	Q3
LM4041DQDBZT	SOT-23	DBZ	3	250	178.0	9.2	3.15	2.77	1.22	4.0	8.0	Q3

PACKAGE MATERIALS INFORMATION

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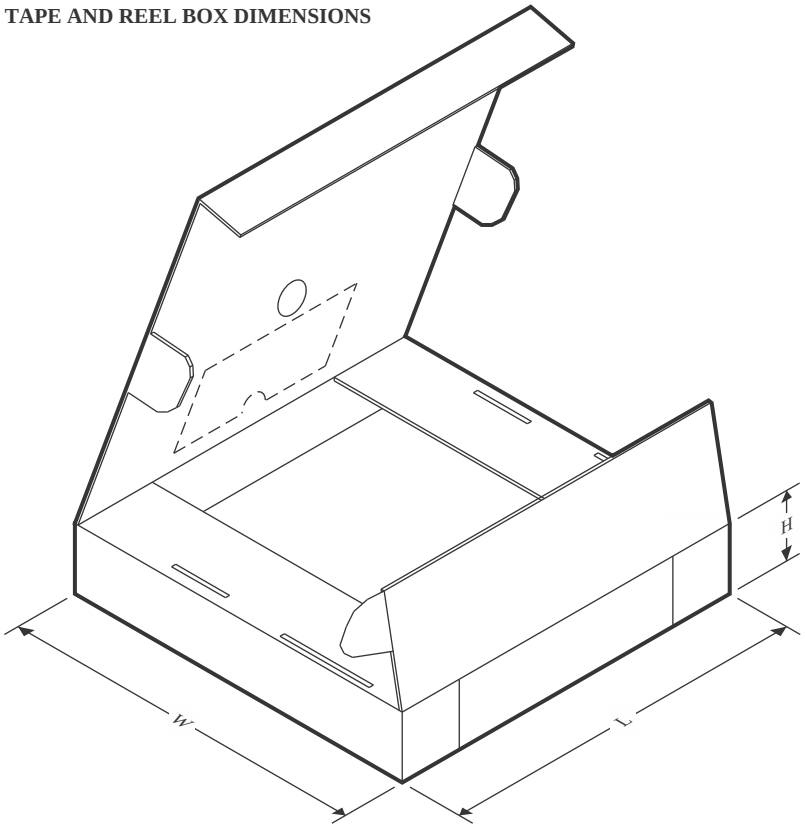
13-Dec-2025

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM4041A12IDBZR	SOT-23	DBZ	3	3000	210.0	185.0	35.0
LM4041A12IDBZT	SOT-23	DBZ	3	250	210.0	185.0	35.0
LM4041A12IDBZT1G4	SOT-23	DBZ	3	250	210.0	185.0	35.0
LM4041A12IDCKR	SC70	DCK	5	3000	210.0	185.0	35.0
LM4041A12IDCKR	SC70	DCK	5	3000	200.0	183.0	25.0
LM4041B12IDBZR	SOT-23	DBZ	3	3000	210.0	185.0	35.0
LM4041B12IDBZT	SOT-23	DBZ	3	250	210.0	185.0	35.0
LM4041B12IDCKR	SC70	DCK	5	3000	200.0	183.0	25.0
LM4041B12IDCKR	SC70	DCK	5	3000	210.0	185.0	35.0
LM4041BIDBZR	SOT-23	DBZ	3	3000	200.0	183.0	25.0
LM4041BIDBZR	SOT-23	DBZ	3	3000	180.0	180.0	18.0
LM4041BIDBZR1G4	SOT-23	DBZ	3	3000	180.0	180.0	18.0
LM4041BIDBZR1G4	SOT-23	DBZ	3	3000	200.0	183.0	25.0
LM4041BIDBZT	SOT-23	DBZ	3	250	180.0	180.0	18.0
LM4041BIDBZT	SOT-23	DBZ	3	250	200.0	183.0	25.0
LM4041BIDCKR	SC70	DCK	5	3000	200.0	183.0	25.0
LM4041BIDCKT	SC70	DCK	5	250	203.0	203.0	35.0
LM4041C12IDBZR	SOT-23	DBZ	3	3000	210.0	185.0	35.0

PACKAGE MATERIALS INFORMATION

www.ti.com

13-Dec-2025

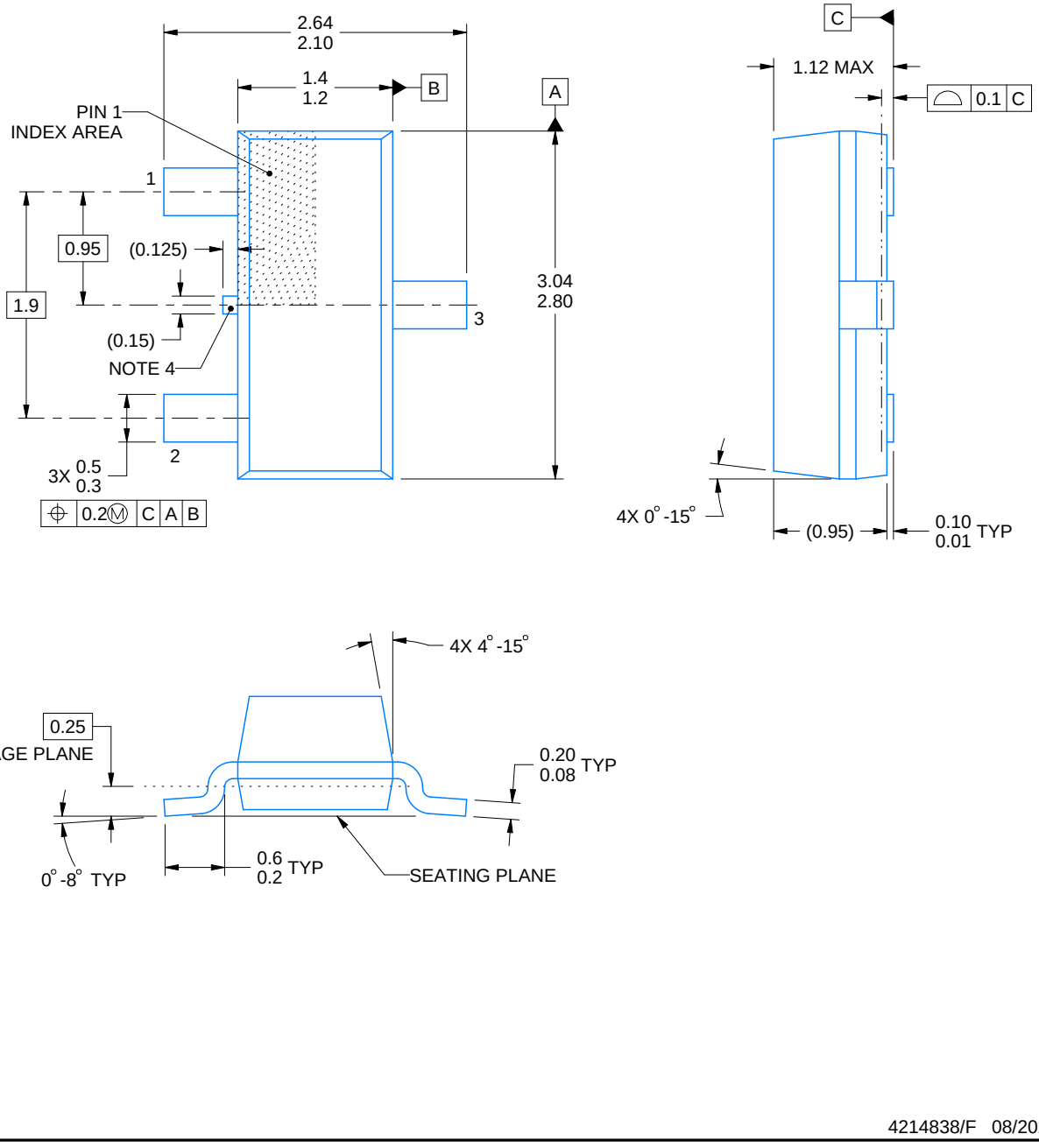
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM4041C12IDBZR	SOT-23	DBZ	3	3000	200.0	183.0	25.0
LM4041C12IDBZR1G4	SOT-23	DBZ	3	3000	210.0	185.0	35.0
LM4041C12IDBZT	SOT-23	DBZ	3	250	210.0	185.0	35.0
LM4041C12IDCKR	SC70	DCK	5	3000	210.0	185.0	35.0
LM4041C12IDCKR	SC70	DCK	5	3000	200.0	183.0	25.0
LM4041C12QDBZR	SOT-23	DBZ	3	3000	210.0	185.0	35.0
LM4041C12QDBZT	SOT-23	DBZ	3	250	210.0	185.0	35.0
LM4041CIDBZR	SOT-23	DBZ	3	3000	200.0	183.0	25.0
LM4041CIDBZR	SOT-23	DBZ	3	3000	180.0	180.0	18.0
LM4041CIDBZT	SOT-23	DBZ	3	250	180.0	180.0	18.0
LM4041CIDBZT	SOT-23	DBZ	3	250	203.0	203.0	35.0
LM4041CIDCKR	SC70	DCK	5	3000	200.0	183.0	25.0
LM4041CIDCKT	SC70	DCK	5	250	200.0	183.0	25.0
LM4041CQDBZR	SOT-23	DBZ	3	3000	200.0	183.0	25.0
LM4041CQDBZR	SOT-23	DBZ	3	3000	180.0	180.0	18.0
LM4041CQDBZT	SOT-23	DBZ	3	250	180.0	180.0	18.0
LM4041CQDBZT	SOT-23	DBZ	3	250	200.0	183.0	25.0
LM4041D12IDBZR	SOT-23	DBZ	3	3000	210.0	185.0	35.0
LM4041D12IDBZR1G4	SOT-23	DBZ	3	3000	210.0	185.0	35.0
LM4041D12IDBZT	SOT-23	DBZ	3	250	210.0	185.0	35.0
LM4041D12IDCKR	SC70	DCK	5	3000	200.0	183.0	25.0
LM4041D12IDCKR	SC70	DCK	5	3000	210.0	185.0	35.0
LM4041D12QDBZR	SOT-23	DBZ	3	3000	210.0	185.0	35.0
LM4041DIDBZR	SOT-23	DBZ	3	3000	200.0	183.0	25.0
LM4041DIDBZR	SOT-23	DBZ	3	3000	180.0	180.0	18.0
LM4041DIDBZT	SOT-23	DBZ	3	250	180.0	180.0	18.0
LM4041DIDCKR	SC70	DCK	5	3000	200.0	183.0	25.0
LM4041DIDCKRG4	SC70	DCK	5	3000	200.0	183.0	25.0
LM4041DQDBZR	SOT-23	DBZ	3	3000	180.0	180.0	18.0
LM4041DQDBZR	SOT-23	DBZ	3	3000	200.0	183.0	25.0
LM4041DQDBZT	SOT-23	DBZ	3	250	203.0	203.0	35.0
LM4041DQDBZT	SOT-23	DBZ	3	250	180.0	180.0	18.0

PACKAGE OUTLINE

DBZ0003A

SOT-23 - 1.12 mm max height

SMALL OUTLINE TRANSISTOR



4214838/F 08/2024

NOTES:

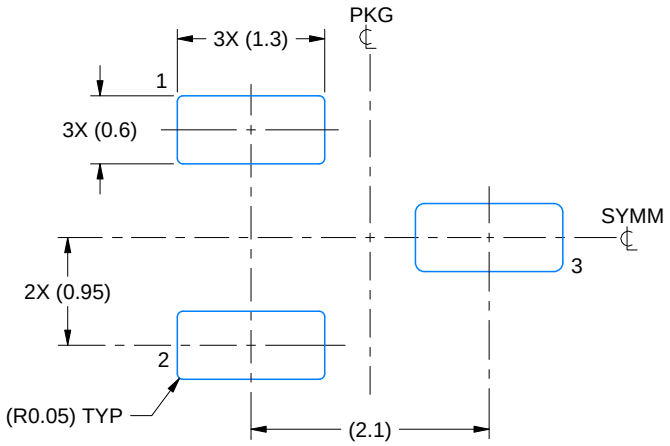
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC registration TO-236, except minimum foot length.
4. Support pin may differ or may not be present.
5. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side

EXAMPLE BOARD LAYOUT

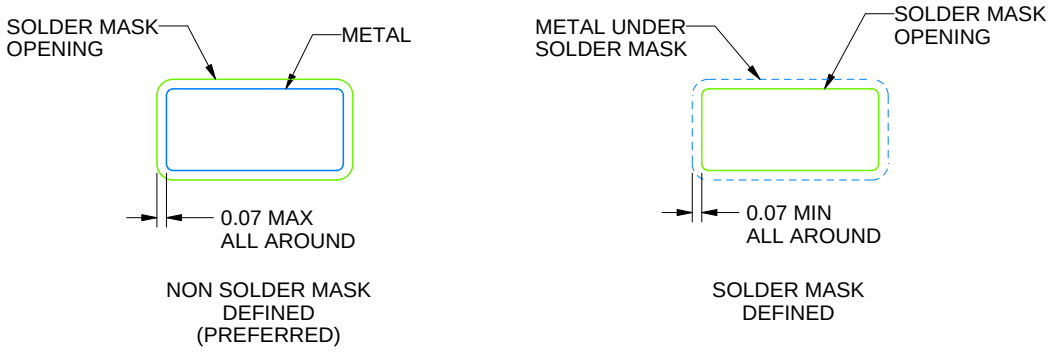
DBZ0003A

SOT-23 - 1.12 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE
SCALE:15X



SOLDER MASK DETAILS

4214838/F 08/2024

NOTES: (continued)

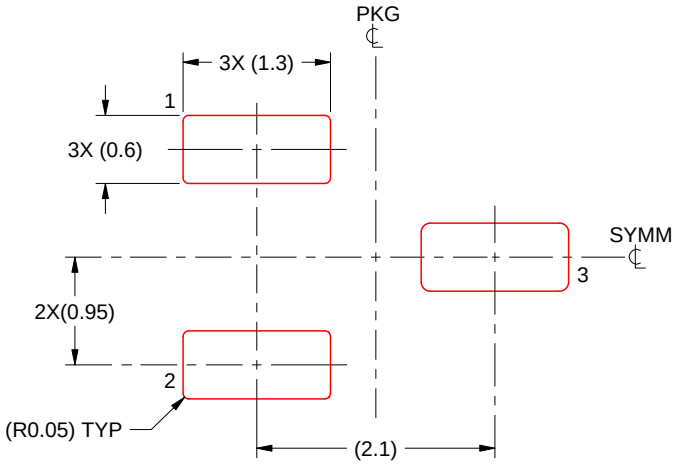
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DBZ0003A

SOT-23 - 1.12 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE
BASED ON 0.125 THICK STENCIL
SCALE:15X

4214838/F 08/2024

NOTES: (continued)

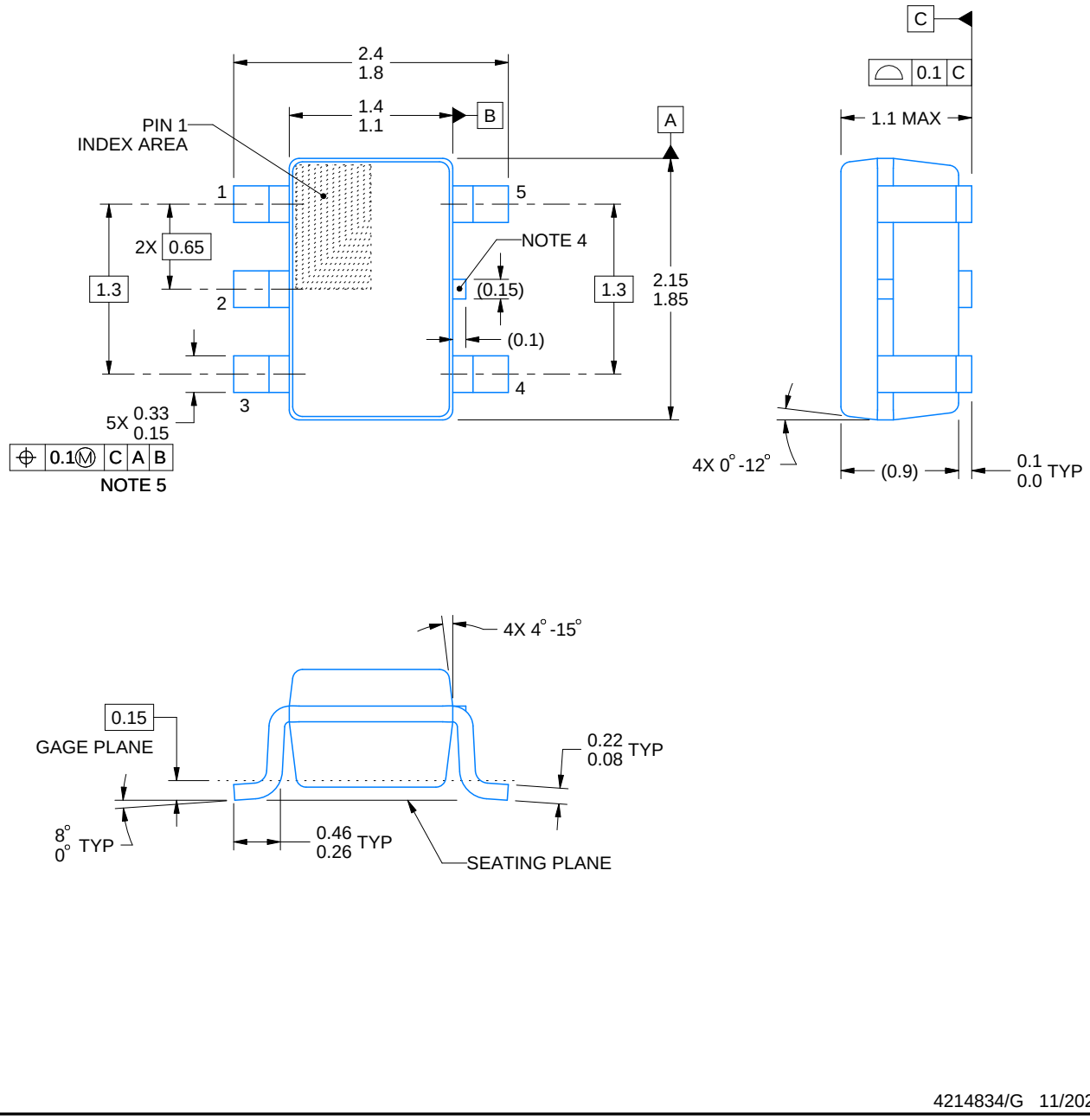
7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

PACKAGE OUTLINE

DCK0005A

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



4214834/G 11/2024

NOTES:

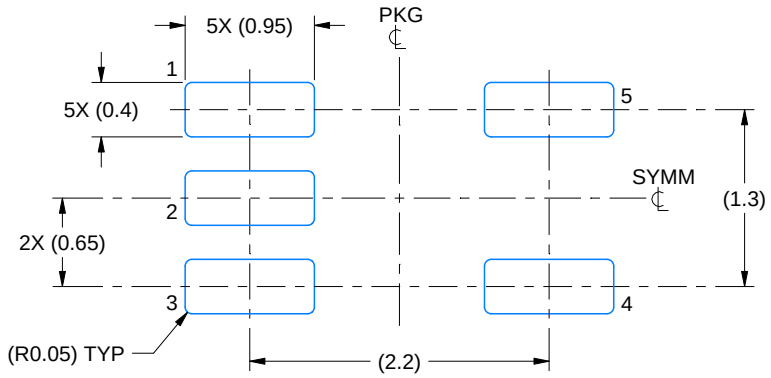
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Refernce JEDEC MO-203.
4. Support pin may differ or may not be present.
5. Lead width does not comply with JEDEC.
6. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side

EXAMPLE BOARD LAYOUT

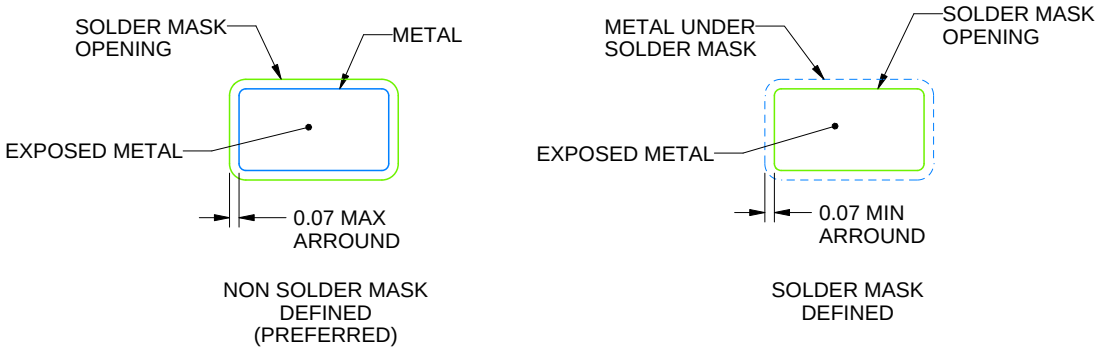
DCK0005A

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:18X



SOLDER MASK DETAILS

4214834/G 11/2024

NOTES: (continued)

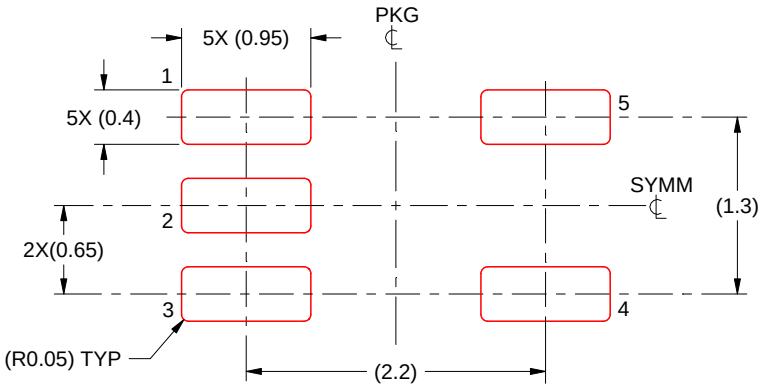
7. Publication IPC-7351 may have alternate designs.
8. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DCK0005A

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE
BASED ON 0.125 THICK STENCIL
SCALE:18X

4214834/G 11/2024

NOTES: (continued)

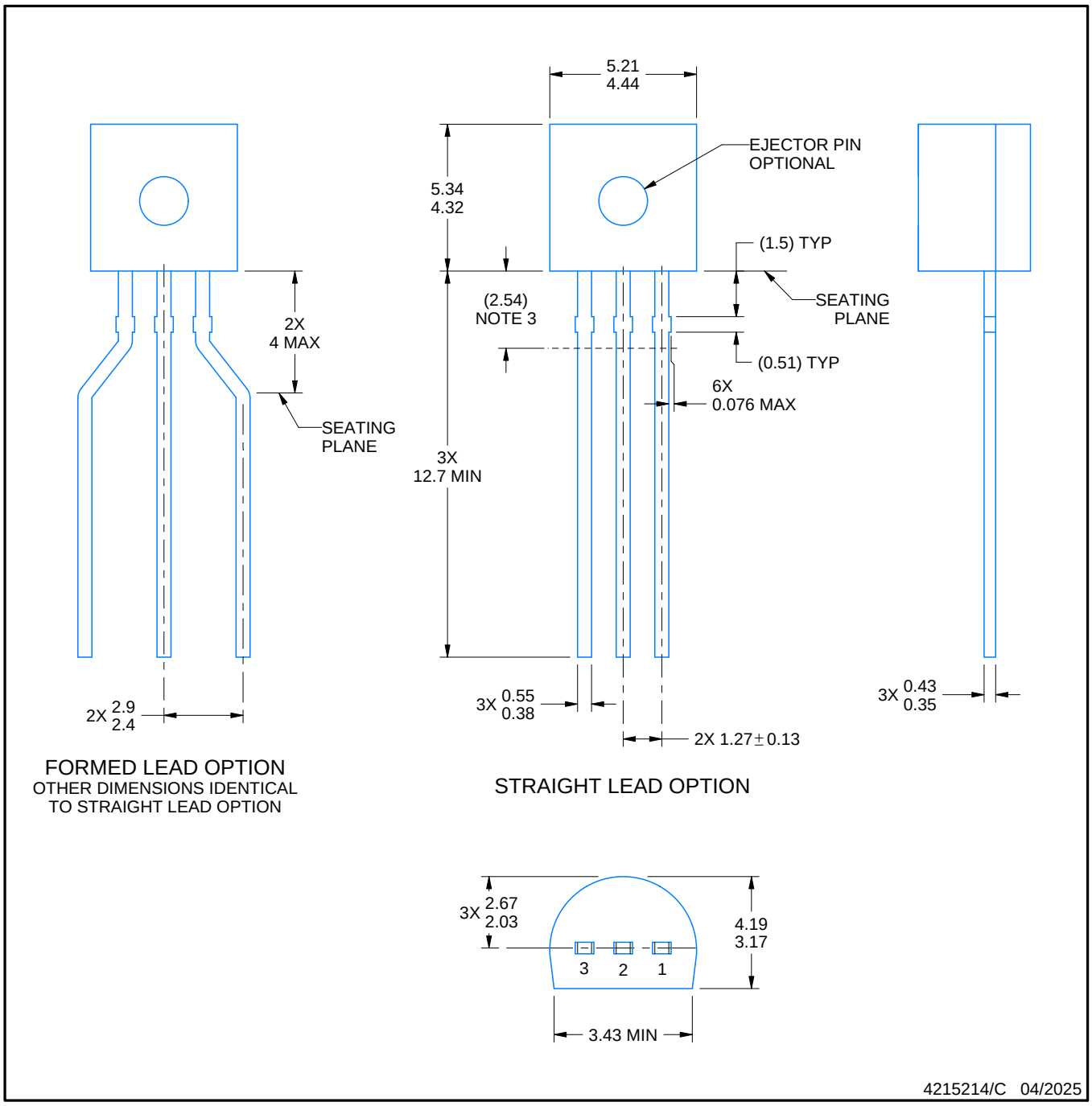
9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
10. Board assembly site may have different recommendations for stencil design.

PACKAGE OUTLINE

LP0003A

TO-92 - 5.34 mm max height

TO-92



NOTES:

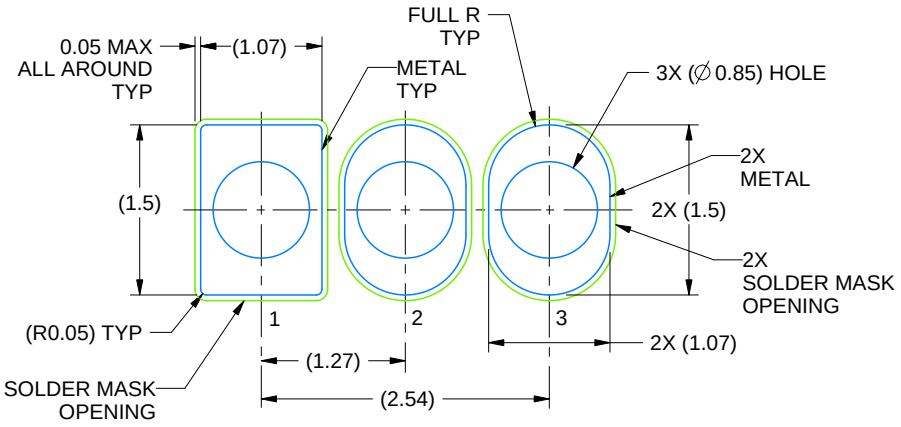
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Lead dimensions are not controlled within this area.
4. Reference JEDEC TO-226, variation AA.
5. Shipping method:
   a. Straight lead option available in bulk pack only.
   b. Formed lead option available in tape and reel or ammo pack.
   c. Specific products can be offered in limited combinations of shipping medium and lead options.
   d. Consult product folder for more information on available options.

EXAMPLE BOARD LAYOUT

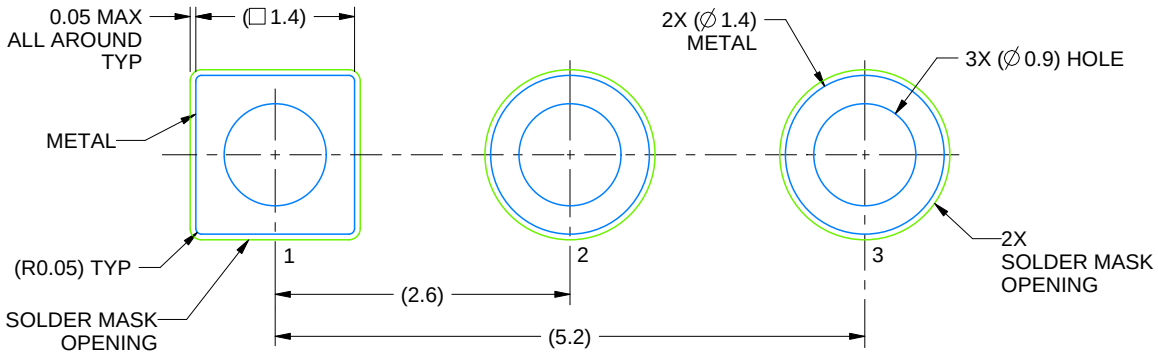
LP0003A

TO-92 - 5.34 mm max height

TO-92



LAND PATTERN EXAMPLE
STRAIGHT LEAD OPTION
NON-SOLDER MASK DEFINED
SCALE:15X



LAND PATTERN EXAMPLE
FORMED LEAD OPTION
NON-SOLDER MASK DEFINED
SCALE:15X

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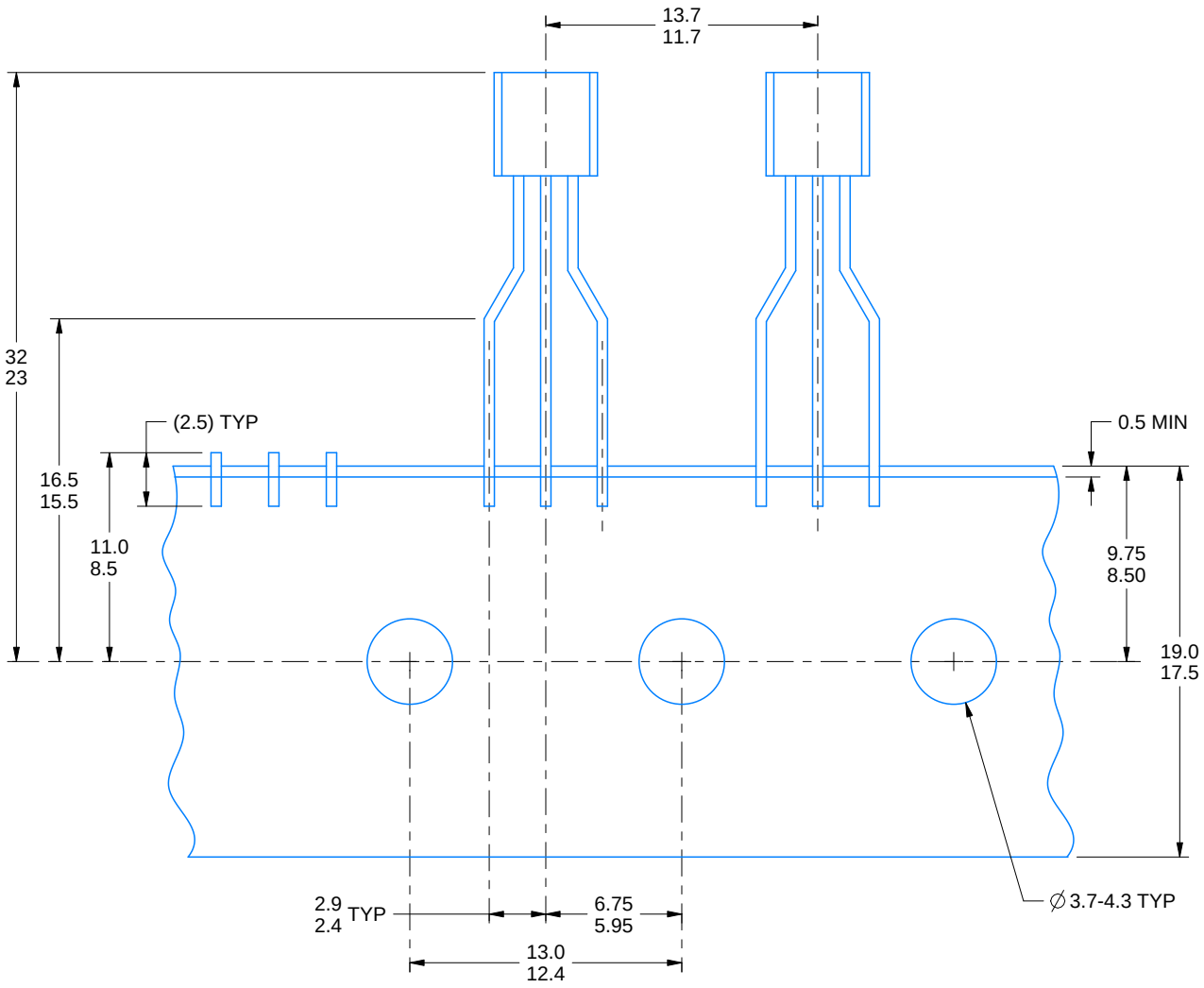
TAPE SPECIFICATIONS

LP0003A

TO-92 - 5.34 mm max height

TO-92



FOR FORMED LEAD OPTION PACKAGE

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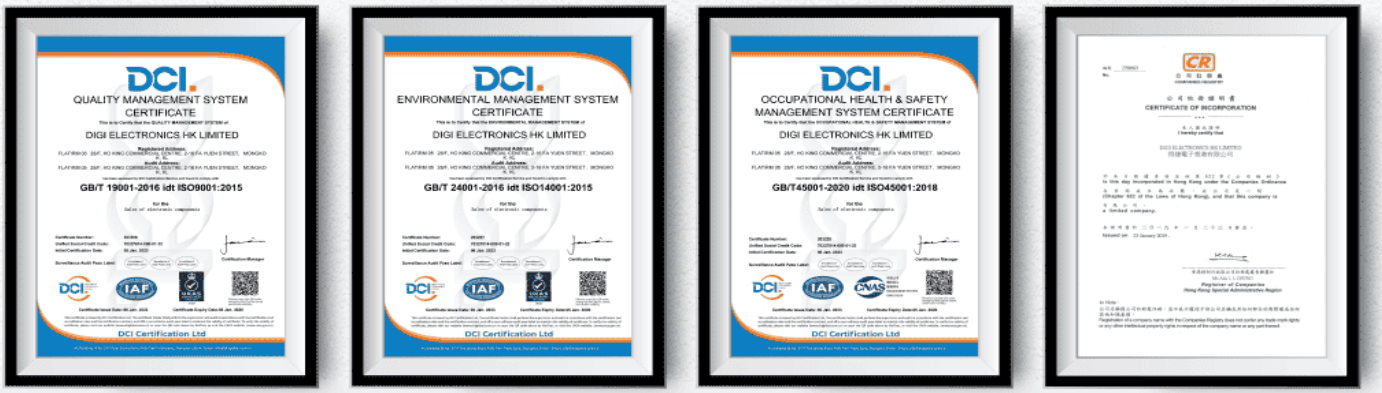

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